Paper Title for LTB-3D

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Abstract—A short summary (max 300 characters) of the work can go here. A short summary of the work can go here. A short summary of the work can go here. A short summary of the work can go here. A short summary of the work can go here. A short summary of the work can go here.

I. INTRODUCTION AND BACKGROUND

This document is a template derived from the standard IEEE style template for papers and transactions. The template is for Microsoft *Word*.

This template should be used for summary submissions to the 9th International Workshop on Low Temperature Bonding for 3D Integration (LTB-3D 2026) to be held from May 13-15, 2026, at Kanazawa Bunka Hall. Please refer to the conference website for details: https://imsi.jp/ltb3d/ltb3d-2026/index.html

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II. RESULTS

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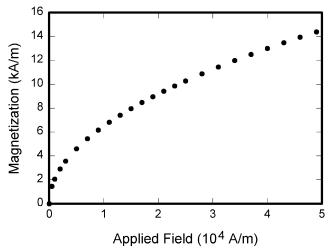


Fig. 1. Magnetization as a function of applied field. Note that "Fig." is abbreviated. There is a period after the figure number, followed by two spaces. It is good practice to explain the significance of the figure in the caption.

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A conclusion section is not required.

ACKNOWLEDGMENT

The preferred spelling of the word "acknowledgment" in American English is without an "e" after the "g." Use the singular heading even if you have many acknowledgments.

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